

## SK12B THRU SK110B

1.0 AMPS. Surface Mount Schottky Barrier Rectifiers



Voltage Range 20 to 100 Volts Current 1.0 Amperes

SMB/DO-214AA

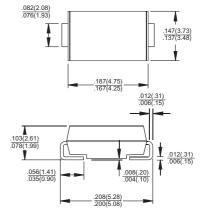
#### **Features**

- ♦ For surface mounted application
- Metal to silicon rectifier, majority carrier conduction
- ♦ Low forward voltage drop
- ♦ Easy pick and place
- ♦ High surge current capability
- Plastic material used carriers Underwriters Laboratory Classification 94V-O
- Epitaxial construction
- High temperature soldering:
   260°C / 10 seconds at terminals

#### **Mechanical Data**

- ♦ Case: Molded plastic
- ♦ Terminals: Solder plated
- Polarity: Indicated by cathode band
- ♦ Packaging: 16mm tape per EIA STD RS-481
- ♦ Weight: 0.093 gram

# 32(2.08)



Dimensions in inches and (millimeters)

### **Maximum Ratings and Electrical Characteristics**

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	SK 12B	SK 13B	SK 14B	SK 15B	SK 16B	SK 110B	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	20	30	40	50	60	100	V
Maximum RMS Voltage	$V_{RMS}$	14	21	28	35	42	70	V
Maximum DC Blocking Voltage	$V_{DC}$	20	30	40	50	60	100	V
Maximum Average Forward Rectified Current at $T_A$ =75 $^{\circ}$ C	I <sub>(AV)</sub>	1.0						Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	38						Α
Maximum Instantaneous Forward Voltage @ 1.0A	V <sub>F</sub>	0.5 0.75 0.85				V		
Maximum DC Reverse Current (Note 1)@ T <sub>A</sub> =25°C		0.5						mΑ
at Rated DC Blocking Voltage @ T <sub>A</sub> =100℃	$I_R$	10.0 5.0 1.0			1.0	mΑ		
Typical Thermal Resistance ( Note 1 )	$R\theta_{JL}$	25						€\M
Typical Junction Capacitance (Note 2)	Cj	110						pF
Operating Temperature Range	Τ <sub>J</sub>	-55 to +125						င
Storage Temperature Range	$T_{STG}$	-55 to +150						${\mathbb C}$

- Notes: 1. Thermal Resistance from Junction to Lead.
  - 2. Measured at 1.0 MHz and Applies Reverse Voltage of 4.0V.
  - 3. Measured on P.C.Board with 0.4 x 0.4" (10 x 10mm) Copper Pad Areas.



100



FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

1.0

RESISTIVE OR INDUCTIVE LOAD

SS12B- SS14B

SS16B SS16B

SS16B SS16B

PCB MOUNTED ON 0.4X0.4\*

(10X10mm) COPPER PAD AREAS

0 50 60 70 80 90 100 110 120 130 140 150 160 170

LEAD TEMPERATURE. (°C)

FIG.2- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

To AT RATED TL

AT RATED TL

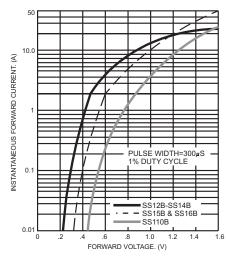
B.3ms Single Half Sine Wave JEDEC Method

JEDEC Method

10

NUMBER OF CYCLES AT 60Hz

FIG.3- TYPICAL FORWARD CHARACTERISTICS



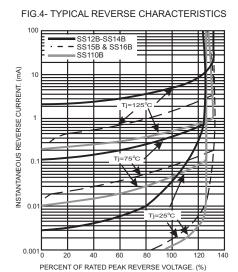


FIG.5- TYPICAL JUNCTION CAPACITANCE

